

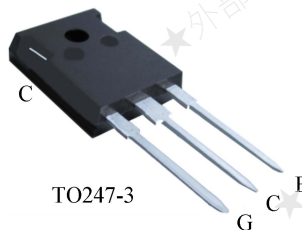
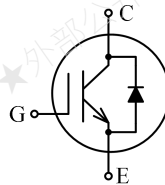


IGBT in advanced Trench FS Technology with soft and fast recovery anti-parallel diode
具有先进 Trench FS 技术的 IGBT 且反并联软快恢复二极管

Features

特性

- 650V trench field-stop technology
650V沟槽场终止技术
- Low saturation voltage
低饱和压降
- Negative temperature coefficient of forward voltage
正向电压负温度系数
- Low gate charge
低栅极电荷



Applications

应用

- Electric Automotive Air-Condition Compressor
电动汽车空调压缩机
- Electric Automotive PTC Heater
汽车PTC加热器
- Inverter
变频器

Ordering Information

订货信息

Type 型号	$V_{CE}[V]$ 集电极-发射极 电压	$I_C[A]$ 集电极电流	$V_{CEsat}[V]$ 饱和电压	$T_{jmax}[^{\circ}C]$ 最高结温	Marking 标记	Package 封装
BGNE40V65SD	650	40	1.5	175	40V65SD	TO-247-3L



Maximum Rated Values

最大额定参数

Parameter 参数	Symbol 符号	Value 值	Unit 单位
Collector-emitter voltage, $T_j \geq 25^\circ\text{C}$ 集电极-发射极电压, $T_j \geq 25^\circ\text{C}$	V_{CE}	650	V
Collector current, $T_c = 25^\circ\text{C}$ 集电极电流, $T_c = 25^\circ\text{C}$	I_C	80	A
Collector current, $T_c = 100^\circ\text{C}$ 集电极电流, $T_c = 100^\circ\text{C}$	I_C	40	A
Pulsed collector current, t_p limited by T_{jmax} 集电极脉冲电流, 脉宽时间受 T_{jmax} 限制	I_{Cpuls}	160	A
Diode forward current, $T_c = 25^\circ\text{C}$ 二极管正向电流, $T_c = 25^\circ\text{C}$	I_F	80	A
Diode forward current, $T_c = 100^\circ\text{C}$ 二极管正向电流, $T_c = 100^\circ\text{C}$	I_F	40	A
Diode pulsed current 二极管脉冲电流	I_{Fpuls}	160	A
Gate-emitter voltage 栅极-发射极电压	V_{GE}	± 20	V
Total power dissipation, $T_c = 25^\circ\text{C}$ 总耗散功率, $T_c = 25^\circ\text{C}$	P_{tot}	367	W
Operating junction temperature 最高结温	T_{jmax}	175	$^\circ\text{C}$
Operating junction temperature 工作结温	T_{jop}	$-40 \dots +150$	$^\circ\text{C}$
Storage temperature 储存温度	T_{stg}	$-40 \dots +150$	$^\circ\text{C}$
Soldering temperature, 1.6mm from case for 10s 焊接温度	T_{st}	260	$^\circ\text{C}$

Thermal Resistance

热阻

Parameter 参数	Symbol 符号	Value 值	Unit 单位
IGBT Thermal resistance junction to case IGBT 结-管壳热阻	$R_{th(j-c)}$	0.34	$^\circ\text{C}/\text{W}$
Diode Thermal resistance junction to case 二极管结-管壳热阻	$R_{th(j-c)}$	0.95	$^\circ\text{C}/\text{W}$
Thermal resistance junction to ambient 结-环境热阻	$R_{th(j-a)}$	40	$^\circ\text{C}/\text{W}$



Electrical Characteristic at $T_j=25^\circ\text{C}$ (unless otherwise specified)

$T_j=25^\circ\text{C}$ 时电学特性（除非特别声明）

Parameter 参数	Symbol 符号	Conditions 条件	Value 值			Unit 单位
			Min. 最小值	Typ. 典型值	Max. 最大值	

Static Characteristic

静态特性

Collector-emitter breakdown voltage 集电极-发射极击穿电压	$V_{(BR)CES}$	$V_{GE}=0V, I_C=100\mu A$		650	-	-	V
Collector-emitter saturation voltage 集电极-发射极饱和电压	V_{CESat}	$V_{GE}=15V, I_C=40A$	$T_j=25^{\circ}C$	-	1.5	1.9	V
			$T_j=150^{\circ}C$	-	1.9	-	V
Diode forward voltage 二极管正向电压	V_F	$V_{GE}=0V, I_F=40A$	$T_j=25^{\circ}C$	-	1.9	2.2	V
			$T_j=150^{\circ}C$	-	1.6	-	V
Gate-emitter threshold voltage 栅极-发射极阈值电压	$V_{GE(th)}$	$I_C=1mA, V_{CE}=V_{GE}$		4	5.1	6	V
Collector-emitter cut-off current 集电极-发射极截止电流	I_{CES}	$V_{CE}=650V, V_{GE}=0V$		-	-	100	μA
Gate-emitter leakage current 栅极-发射极漏电流	I_{GES}	$V_{CE}=0V, V_{GE}=\pm 20V$		-100	-	100	nA

Dynamic Characteristic

动态特性

Input capacitance 输入电容	C_{ies}	$V_{CE}=25V, V_{GE}=0V, f=1MHz$	-	1855	-	pF
Output capacitance 输出电容	C_{oes}		-	123	-	pF
Reverse transfer capacitance 反向传输电容	C_{res}		-	20.8	-	pF
Gate charge 门极电阻	R_G	$V_{GE}=0V, V_{CE}=0V, f=1MHz$	-	2.13	-	Ω

Notes:

a: FRD features negative temperature coefficient. Parallel connection is forbidden.

注:

a: FRD 负温度系数，禁止并联使用。



Switching Characteristic at $T_j=25^\circ\text{C}$ (Inductive Load)

$T_j=25^\circ\text{C}$ 时开关特性（感性负载）

Parameter 参数	Symbol 符号	Conditions 条件	Value 值			Unit 单位
			Min. 最小 值	Typ. 典型 值	Max. 最大 值	

IGBT Characteristic

IGBT 特性

Turn-on delay time 开通延迟时间	$t_{d(on)}$	$V_{CE}=400V$, $I_C=40A$, $V_{GE}=15V$, $R_G=10\Omega$, $T_j=25^\circ\text{C}$, Energy losses include "tail" and diode reverse recovery.	-	57.1	-	ns
Rise time 上升时间	t_r		-	78.1	-	ns
Turn-off delay time 关断延迟时间	$t_{d(off)}$		-	109.8	-	ns
Fall time 下降时间	t_f		-	67.7	-	ns
Turn-on energy 开通损耗	E_{on}		-	1.18	-	mJ
Turn-off energy 关断损耗	E_{off}		-	0.92	-	mJ
Total switching energy 总开关损耗	E_{ts}		-	2.10	-	mJ

Anti-Parallel Diode Characteristic

反并联二极管特性

Reverse recovery time 反向恢复时间	t_{rr}	$V_R=400V$, $I_F=40A$, $T_j=25^\circ\text{C}$	-	148	-	ns
Reverse recovery charge 反向恢复电荷	Q_{rr}		-	0.74	-	μC
Peak reverse recovery current 反向恢复峰值电流	I_{rrm}		-	10.8	-	A
Reverse recovered energy 反向恢复损耗	E_{rec}		-	0.28	-	mJ



Switching Characteristic at $T_j=150^{\circ}\text{C}$ (Inductive Load)

$T_j=150^{\circ}\text{C}$ 时开关特性（感性负载）

Parameter 参数	Symbol 符号	Conditions 条件	Value 值			Unit 单位
			Min. 最小 值	Typ. 典型 值	Max. 最大 值	

IGBT Characteristic

IGBT 特性

Turn-on delay time 开通延迟时间	$t_{d(on)}$	$V_{CE}=400V$, $I_C=40A$, $V_{GE}=15V$, $R_G=10\Omega$, $T_j=150^{\circ}\text{C}$, Energy losses include “tail” and diode reverse recovery.	-	53.3	-	ns
Rise time 上升时间	t_r		-	78.1	-	ns
Turn-off delay time 关断延迟时间	$t_{d(off)}$		-	128	-	ns
Fall time 下降时间	t_f		-	101	-	ns
Turn-on energy 开通损耗	E_{on}		-	1.68	-	mJ
Turn-off energy 关断损耗	E_{off}		-	1.18	-	mJ
Total switching energy 总开关损耗	E_{ts}		-	2.86	-	mJ

Anti-Parallel Diode Characteristic

反并联二极管特性

Reverse recovery time 反向恢复时间	t_{rr}	$V_R=400V$, $I_F=40A$, $T_j=150^{\circ}\text{C}$	-	253	-	ns
Reverse recovery charge 反向恢复电荷	Q_{rr}		-	2.37	-	μC
Peak reverse recovery current 反向恢复峰值电流	I_{rrm}		-	19.4	-	A
Reverse recovered energy 反向恢复损耗	E_{rec}		-	0.83	-	mJ

Typical Characteristics Diagrams

特性曲线

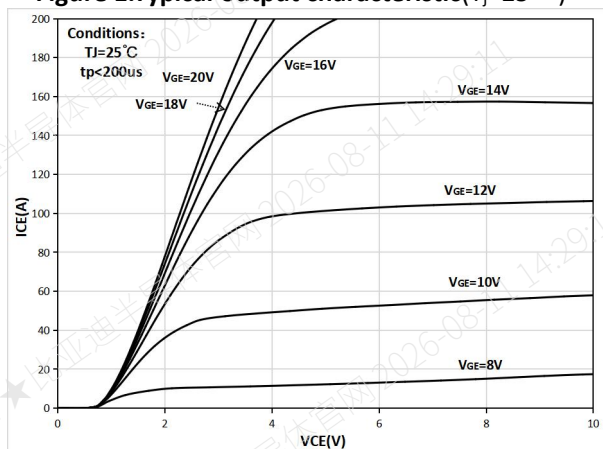
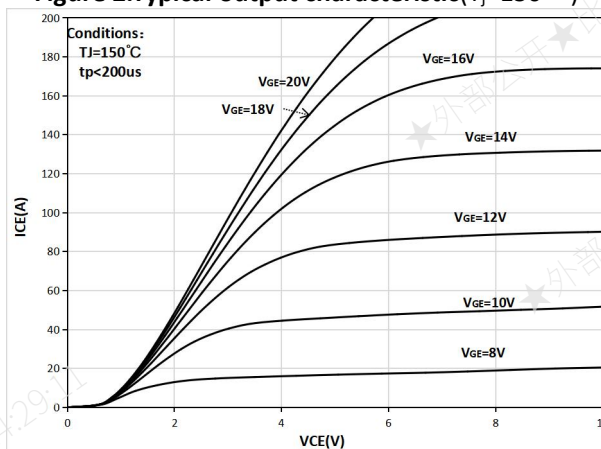
Figure 1. Typical output characteristic ($T_J=25^{\circ}\text{C}$)Figure 2. Typical output characteristic ($T_J=150^{\circ}\text{C}$)

Figure 3. Typical transfer characteristic

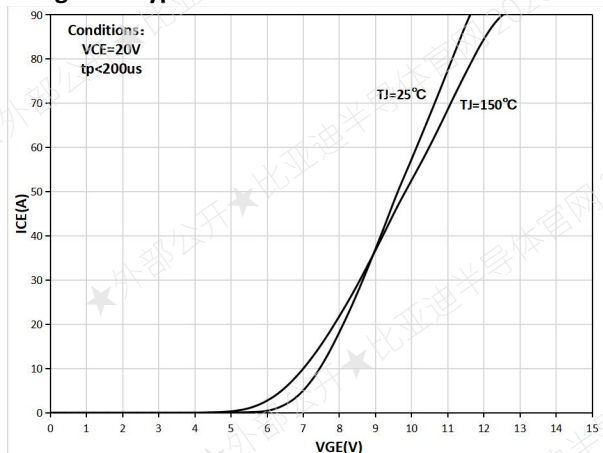


Figure 4. Typical collector current as a function of collector-emitter saturation voltage

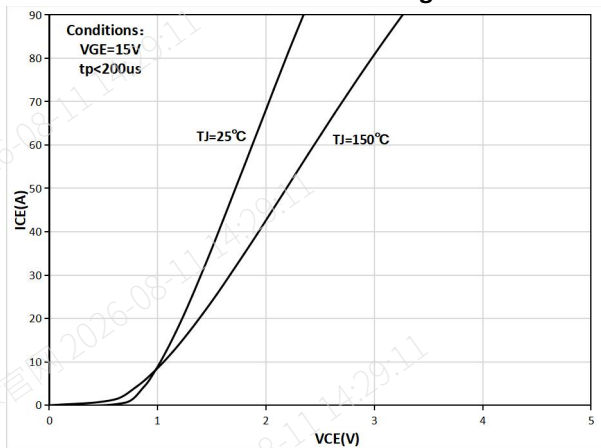


Figure 5. Typical collector-emitter saturation voltage as a function of gate-emitter voltage

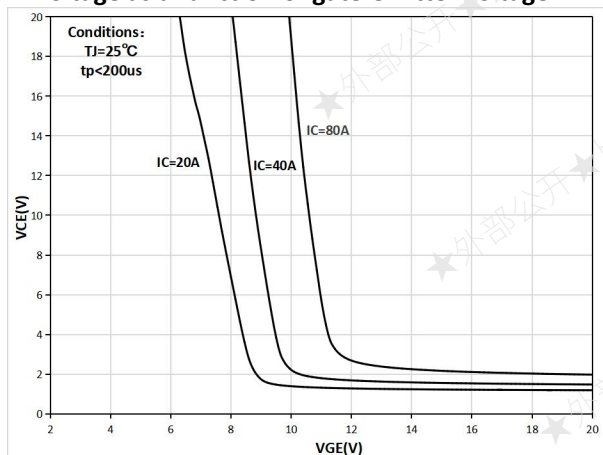


Figure 6. Typical collector-emitter saturation voltage as a function of gate-emitter voltage

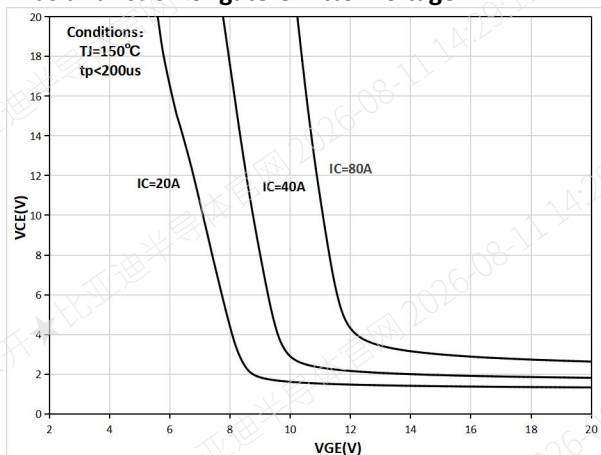




Figure 7. Typical collector-emitter saturation voltage as a function of junction temperature

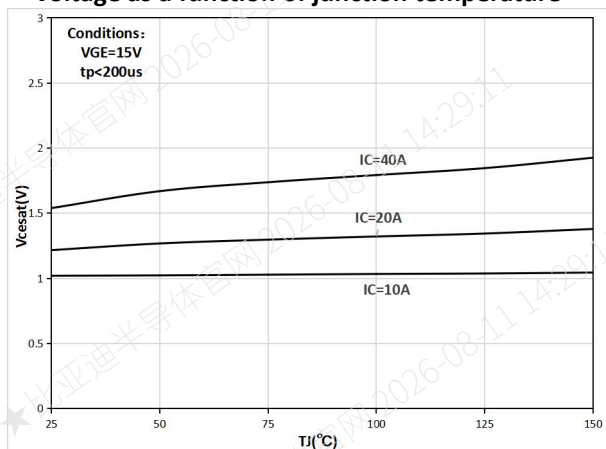


Figure 8. Gate-emitter threshold voltage as a function of junction temperature

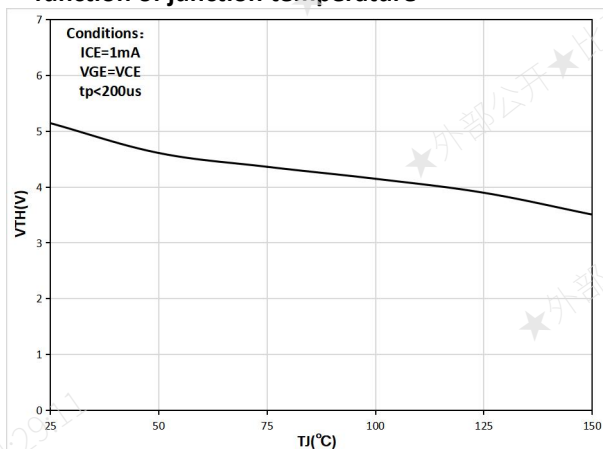


Figure 9. Collector-Emitter breakdown voltage as a function junction temperature

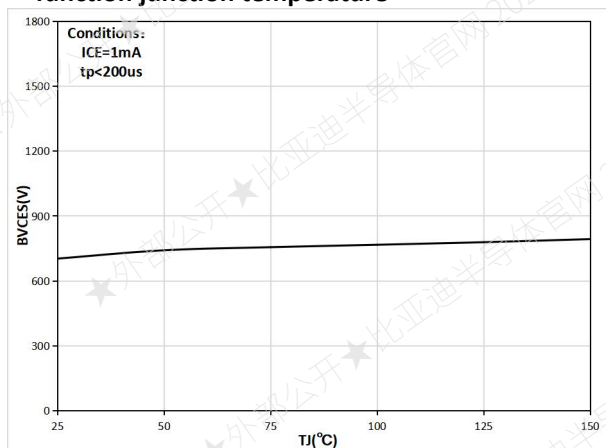


Figure 10. Typical diode foeward current as a function of forward voltage

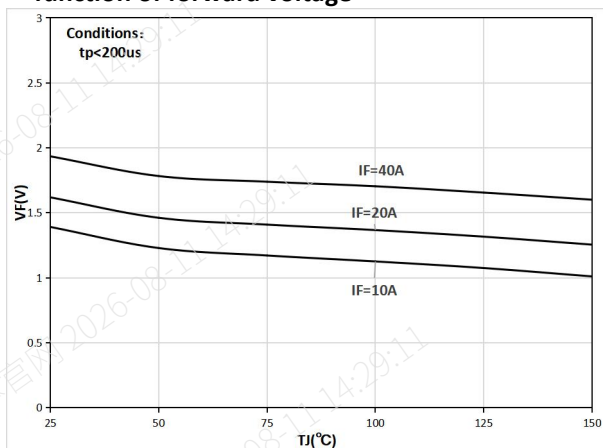


Figure 11. Typical switching energy losses as a function of collector current
(VCE=400V, VGE=15V, RG=10Ω)

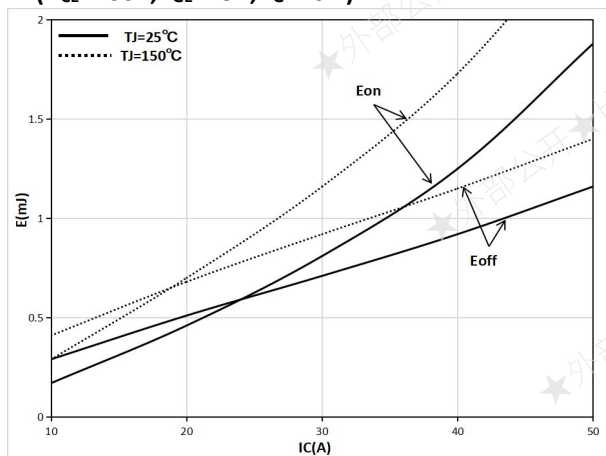


Figure 12. Typical turn-on characteristic as a function of collector current
(VCE=400V, VGE=15V, RG=10Ω)

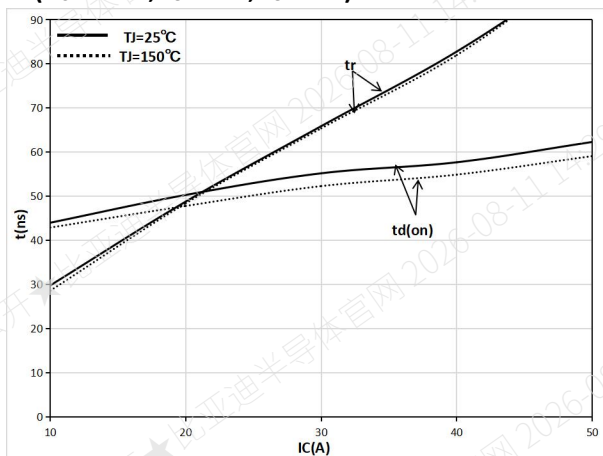


Figure 13. Typical turn-off characteristic as a function of collector current
($V_{CE}=600V, V_{GE}=15V, R_G=10\Omega$)

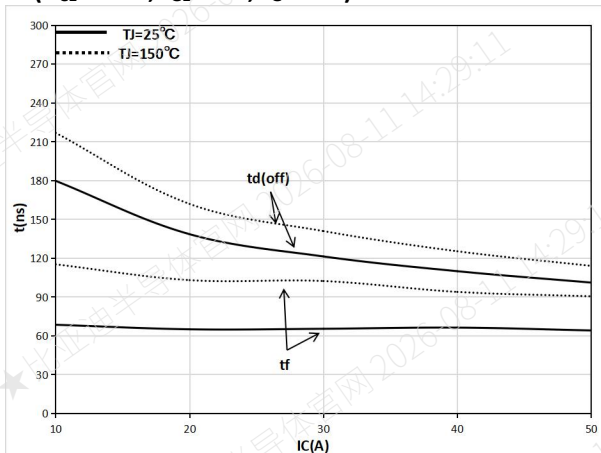


Figure 15. Typical turn-on characteristic as a function of collector emitter voltage
($I_C=40A, V_{GE}=15V, R_G=10\Omega$)

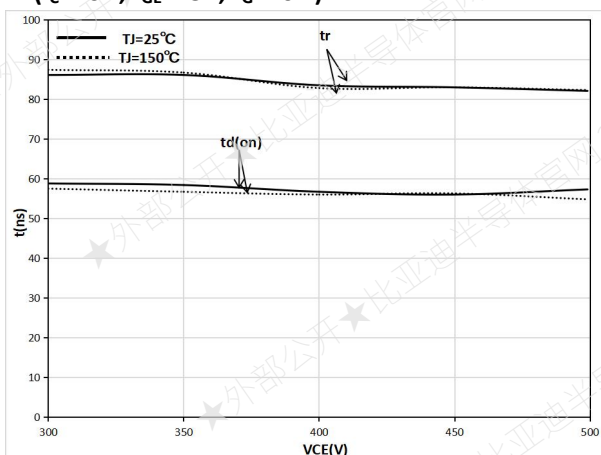


Figure 17. Typical switching energy losses as a function of junction temperature
($V_{CE}=400V, I_C=40A, V_{GE}=15V, R_G=10\Omega$)

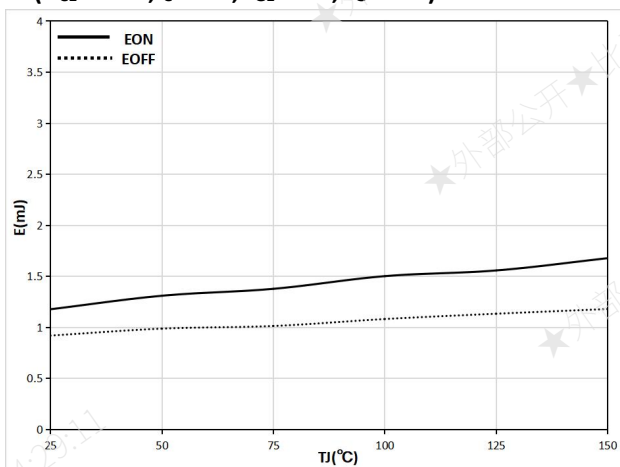


Figure 14. Typical switching energy losses as a function of collector emitter voltage
($I_C=40A, V_{GE}=15V, R_G=10\Omega$)

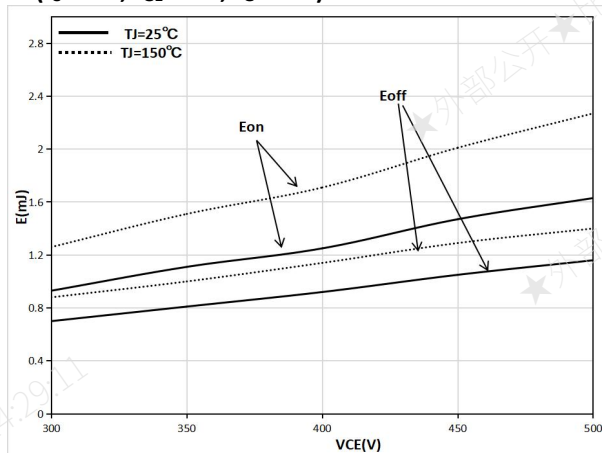


Figure 16. Typical turn-off characteristic as a function of collector emitter voltage
($I_C=40A, V_{GE}=15V, R_G=10\Omega$)

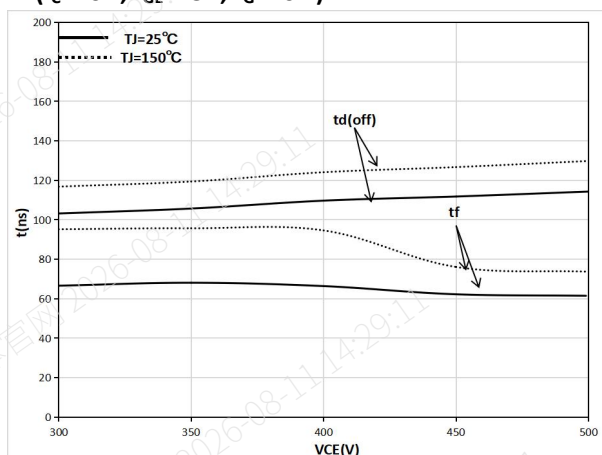


Figure 18. Typical turn-on characteristic as a function of junction temperature
($V_{CE}=400V, I_C=40A, V_{GE}=15V, R_G=10\Omega$)

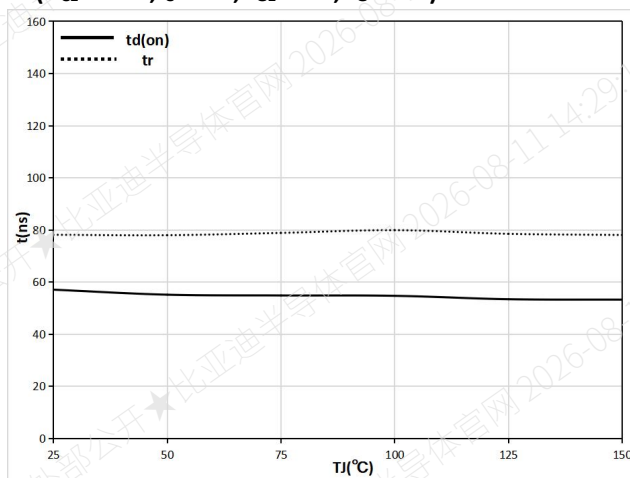


Figure 19. Typical turn-off characteristic as a function of junction temperature
($V_{CE}=400V, I_C=40A, V_{GE}=15V, R_G=10\Omega$)

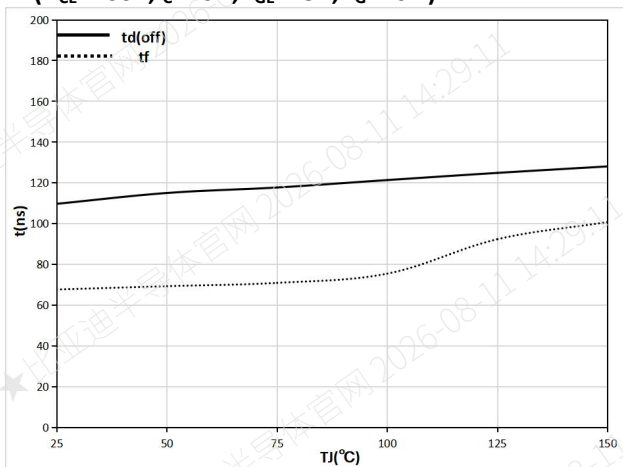


Figure 21. IGBT Transient thermal impedance as a function of pulse width ($D=t_p/T$)

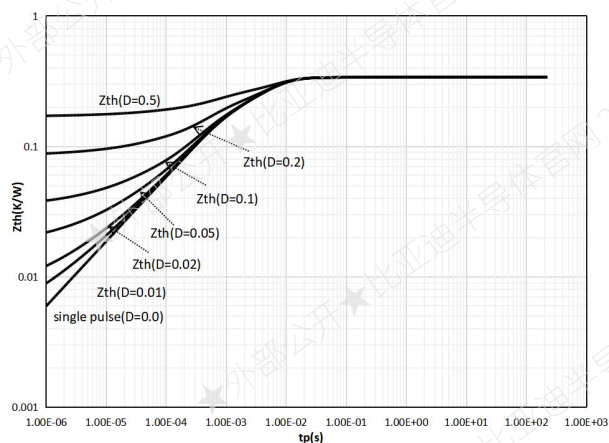


Figure 20. Power dissipation as a function of case temperature ($T_j \leq 150^\circ C$)

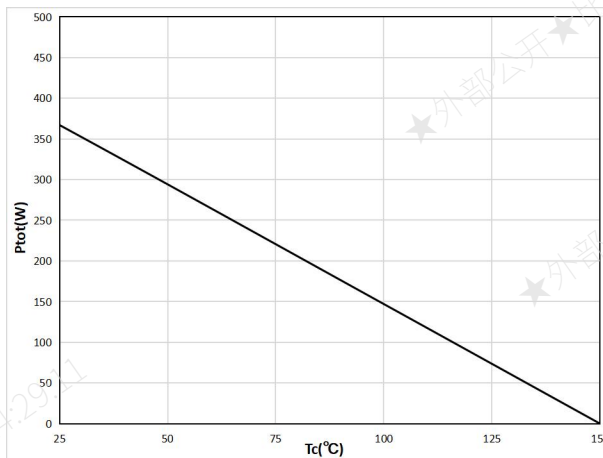
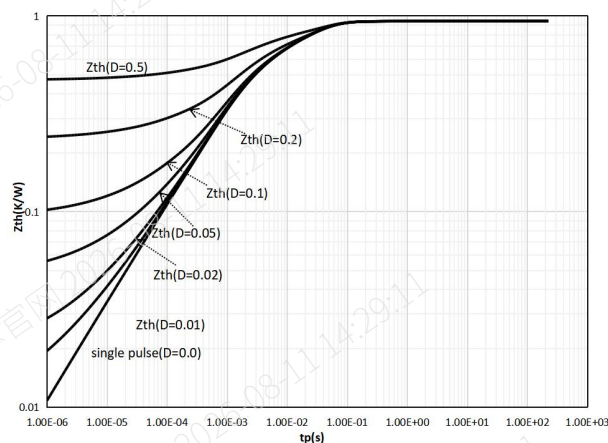


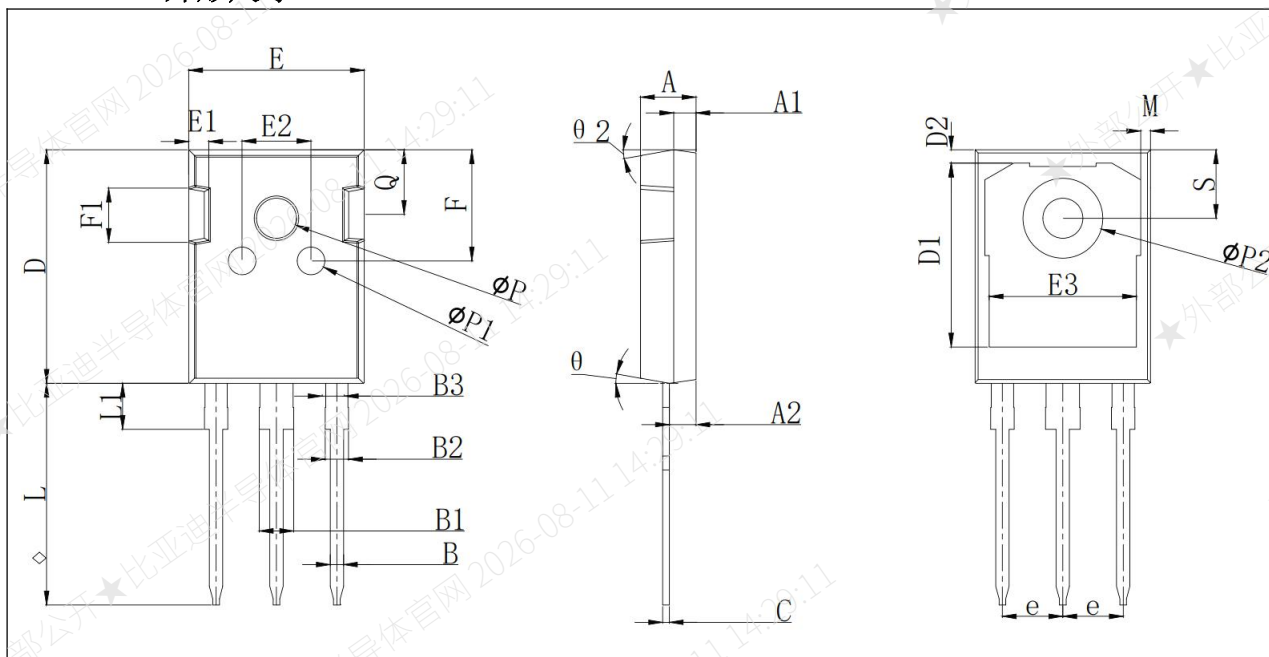
Figure 22. Diode Transient thermal impedance as a function of pulse width ($D=t_p/T$)





TO-247-3L Outline Dimensions:

TO-247-3L 外形尺寸



Common Dimensions (Units:Millimeter)

Symbol	Min.	Max.	Symbol	Min.	Max.
A	4.85	5.15	E3	13.06	14.22
A1	1.90	2.10	F	8.76	10.20
A2	2.20	2.60	F1	4.00	5.30
B	1.00	1.40	e	5.39	5.49
B1	2.80	3.25	L	19.72	21.00
B2	1.80	2.20	L1	3.90	4.80
B3	1.80	2.10	ϕP	3.50	3.70
C	0.50	0.70	$\phi P1$	2.40	3.10
D	20.30	21.10	$\phi P2$	7.10	7.30
D1	16.35	16.75	Q	5.40	5.98
D2	0.85	1.32	S	5.98	6.27
E	15.45	15.90	θ	1°	11°
E1	1.20	2.60	$\theta 2$	9°	23°
E2	6.10	8.20			

Note: Please note that molds can vary between packaging plants. For definitive specifications, please refer to the physical product.

备注：因封装厂的模具存在细微差异，请以实物的尺寸为准。

Packing

包装

Packing 包装	pcs/tube 个/料管	tube/inner box 料管/内盒	inner box/carton 内盒/箱	pcs/carton 个/箱
Tube	30	12	6	2160



DISCLAIMER 免责声明

- Warranty Period: Unless otherwise agreed in the COOPERATION AGREEMENT or other WRITTEN DOCUMENTS, the Warranty Period for products specified in this specification shall be one year from the date of purchase if the products are properly preserved.
Special instructions: Storage Temperature: $20\pm 5^{\circ}\text{C}$; Relative Humidity: 30%-60%; The product should be stored in a place away from direct light and vibration.
质保期: 除双方在合作协议或其他书面文件中另行约定外, 产品妥当保存的情况下自购买之日起, 本规格书所述产品质保期为一年。
特殊说明: 储存温度: $20\pm 5^{\circ}\text{C}$; 相对湿度: 30%-60%; 产品应放置于避光地方, 避免震动。
- Our Company is committed to enhancing product quality and stability. This specification serves solely to delineate technical product details.
本公司致力于提高产品质量与稳定性。本文件之目的, 仅在于陈述产品相关技术信息。
- **Notwithstanding the Company's reasonable efforts and due diligence, the sensitive nature of the products and variations in testing environments and systems may result in a certain failure rate, including potential malfunctions or failures under specific conditions. Consequently, the Company does not warrant the accuracy of the information contained in this specification, nor the fitness for a particular purpose or merchantability of the products. The information in this specification shall not be construed as a guarantee or commitment regarding product functionality, condition, or quality.**
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- **The Company shall not be held liable for any product damage or consequential incidents resulting from usage beyond the recommended storage conditions, operating parameters, or absolute maximum ratings (or other explicitly stated limits) specified in this specification. Customers must strictly adhere to the operational procedures and conditions outlined in the latest version of the specification when utilizing or testing the product. Customers are responsible for complying with**



safety standards, including but not limited to redundant design, fire prevention measures, and fault prevention, to design and maintain a safe and stable system environment. Customers must verify all functionalities described in this specification before or during actual application to ensure product suitability, safety (preventing potential accidents, fires, or public harm etc.), and reliability. It is recommended that Customers consult our company prior to testing to confirm whether the product information adequately covers the application requirements.

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- This product shall not be used in any equipment or applications requiring higher reliability or quality standards where failure could result in personal injury, death, or catastrophic events, including but not limited to nuclear control systems, aircraft/aviation components, maritime/rail transport equipment, traffic signaling devices, combustion control systems, medical equipment, or other safety-critical applications. Customers must procure genuine products exclusively through the Company or authorized channels, and utilize them strictly within legally permitted boundaries and under conditions expressly defined in this specification. The Company disclaims all liability for losses, damages, or injuries arising from non-compliance with these requirements.

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